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2-23-04

To the Director of the United States Patent and Trademark Office: Please record the attached original documents or copy thereof.

1. Name of conveying party(ies):

Junghyun Cho
Scott Oliver
Wayne E. Jones, Jr.
Bahgat Sammakia

Additional names(s) of conveying party(ies) Yes No

2. Name and address of receiving party(ies):

Name: **THE RESEARCH FOUNDATION OF STATE**

Internal Address: **UNIVERSITY OF NEW YORK**

Street Address: _____

City: **Albany** State: **NY** ZIP: _____

Additional name(s) & address(es) attached? Yes No

3. Nature of conveyance:

- Assignment Merger
- Security Agreement Change of Name
- Other _____

Execution Date: **10/6/03; 9/17/03; 9/28/03; 1/23/04**

4. Application number(s) or patent numbers(s):

10785887

If this document is being filed together with a new application, the execution date of the application is: **10/6/03; 9/17/03; 9/28/03**

A. Patent Application No.(s)

B. Patent No.(s)

11/23/04

10/6/04 MARZIL 00000073 10785887

40.00 DP

Additional numbers attached? Yes No

5. Name and address of party to whom correspondence concerning document should be mailed:

Name: **Mark Levy**

Internal Address: **MARK LEVY & ASSOCIATES, PLLC**
Press Building - Ste. 902

Street Address: **19 Chenango Street**

City: **Binghamton** State: **NY** ZIP: **13901**

6. Total number of applications and patents involved:

1

7. Total fee (37 CFR 3.41):.....\$ **40.00**

- Enclosed - Any excess or insufficiency should be credited or debited to deposit account
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8. Deposit account number:

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9. Statement and signature.

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

Mark Levy

2/23/04

Name of Person Signing

Signature

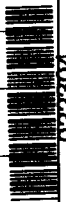
Date

Total number of pages including cover sheet, attachments, and document:

3

22857 U.S. PTO

10785887



022304

**Assignment of Rights, Title and Interest in Invention
(Multiple inventors; single assignee)**

Docket No.
RB-159

This is an Assignment of the following rights, title and interest: (check all that apply):

United States of America rights, title and interest in the invention

Foreign rights, title and interest in the invention

United States Patent Application Serial No. _____

Date of Execution: _____

Date of Filing: _____

United States Provisional Patent Application Serial No. _____

United States Patent No(s). _____

International (PCT) Patent Application Serial No. _____

Other (specify) _____

Title of the Invention

IMPROVED SURFACE COATINGS FOR ELECTRONIC SYSTEMS

Inventors (assignors)

<i>Name</i>	<i>Address</i>
Junghyun Cho	700 Rano Blvd. Vestal, New York 13850
Scott Oliver	3571 Smith Drive, Endwell, New York 13760
Wayne Jones	1433 Carnegie Drive, Vestal, New York 13850
Bahgat Sammakia	878 Powderhouse Road, Binghamton, New York 13903

Assignee

<i>Name</i>	<i>Address</i>
THE RESEARCH FOUNDATION OF STATE UNIVERSITY OF NEW YORK	Albany, New York

**Assignment of Rights, Title and Interest in Invention
(Multiple inventors; single assignee)**

Docket No.
RB-159

Whereas, we, the above-identified Inventors, have invented certain new and useful improvements in the Invention identified above and described in the above-identified patent application(s) and/or patent(s) (hereinafter referred to as "Invention");

And, whereas we desire to assign our above-identified rights, title and interest in the Invention to the above-identified Assignee;

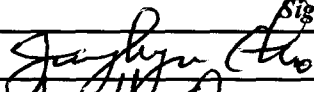
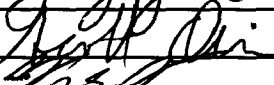


Now, this indenture witnesseth, that for good and valuable consideration, the receipt whereof is hereby acknowledged;

We hereby assign, sell and transfer our above-identified rights, title and interest in said Invention, said application(s) as identified above, including any divisions, continuations, and continuations-in-part thereof, and in and to any and all Letters Patent of the United States, and countries foreign thereto, which may be granted or have granted for said Invention, and in and to any and all reissues and reexaminations thereof, and in and to any and all priority rights, Convention rights, and other benefits accruing or to accrue to us with respect to the filing of applications for patents or securing of patents in the United States and countries foreign thereto, unto said Assignee;

And we hereby authorize and request the Director of the United States Patent and Trademark Office to issue any United States Letters Patent which may issue for said Invention to said Assignee, as assignee of the whole right, title and interest thereto;

And we further agree to sign and execute all necessary and lawful future documents, including applications for foreign patents, for filing divisions, continuations and continuations-in-part of said application for patent, and/or, for obtaining any reissue or reissues of any Letters Patent which may be granted for my aforesaid Invention, as the Assignee or its Designee(s) may from time to time require and prepare at its own expense.

Inventors' Signatures (if Notarization is desired, do not sign here and proceed to next page)

Name	Signature/Date
Junghyun Cho	 1/23/04
Scott Oliver	 10/6/03
Wayne Jones	 9-28-03
Bahgat Sammakia	 9-17-03